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## **FDMS86255** N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 150 V, 45 A, 12.4 m $\Omega$

## **Features**

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)}$  = 12.4 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 10 A
- Max  $r_{DS(on)} = 15.5 \text{ m}\Omega \text{ at } V_{GS} = 6 \text{ V}, I_D = 8 \text{ A}$
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

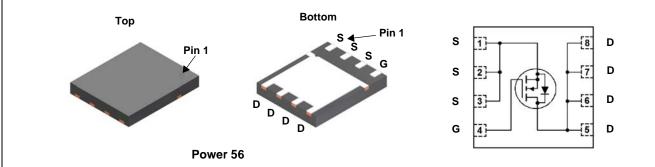


## **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

## Applications

- OringFET / Load Switching
- Synchronous rectification
- DC-DC Conversion



## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter				Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			150	V		
V <sub>GS</sub>	Gate to Source Vo	oltage			±20	V	
	Drain Current	-Continuous	T <sub>C</sub> = 25 °C		45		
I <sub>D</sub>		-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	10	Α	
		-Pulsed		(Note 4)	100		
E <sub>AS</sub>	Single Pulse Aval	anche Energy		(Note 3)	541	mJ	
D	Power Dissipation		T <sub>C</sub> = 25 °C		113	W	
PD	Power Dissipation		T <sub>A</sub> = 25 °C	(Note 1a)	2.7	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range				-55 to +150	°C	

### **Thermal Characteristics**

$R_{\thetaJC}$	Thermal Resistance, Junction to Case	1.1	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	45	C/VV

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86255	FDMS86255	Power 56	13 "	12 mm	3000 units

March 2015

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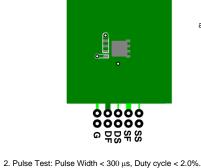
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	150			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		109		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \ \mu A$	2.0	3.0	4.0	V
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-11		mV/°C
r <sub>DS(on)</sub>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		9.5	12.4	mΩ
	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 8 A$		11.5	15.5	
		$V_{GS}$ = 10 V, I <sub>D</sub> = 10 A, T <sub>J</sub> = 125 °C		19	25	
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 10 A$		35		S
Dvnamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			3200	4480	pF
C <sub>oss</sub>	Output Capacitance	── V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V, f = 1 MHz		291	410	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			11	20	pF
R <sub>g</sub>	Gate Resistance		0.1	0.7	2.1	Ω
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			21	34	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 10 A,		4.5	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		28	45	ns
<sup>t</sup> f	Fall Time			6.2	12	ns
ე <sup>g</sup>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		45	63	nC
ک <sup>و</sup>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V V_{DD} = 75 V,$		29	41	nC
^	Coto to Course Charge	$I_{\rm D} = 10  {\rm A}$		14		nC
Q <sub>gs</sub>	Gate to Source Charge	D = 10 A		14		no

### **Drain-Source Diode Characteristics**

V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 1.9 A$	(Note 2)	0.7	1.2	V	
	Source to Drain Diode Porward Voltage	$V_{GS} = 0 V, I_{S} = 10 A$	(Note 2)	0.8	1.3	v	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 10 A, di/dt = 100 A/μs		87	139	ns	
Q <sub>rr</sub>	Reverse Recovery Charge			165	264	nC	

Notes:

1.  $R_{0JA}$  is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{0JC}$  is guaranteed by design while  $R_{0CA}$  is determined by the user's board design.



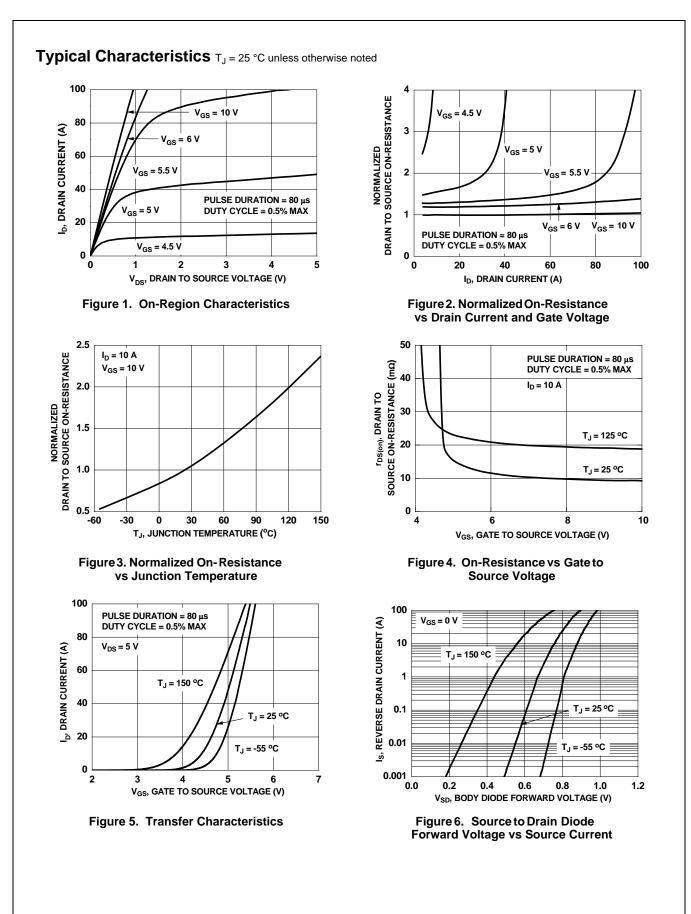
4. Pulse Id refers to Figure.11 Forward Bias Safe Operation Area.

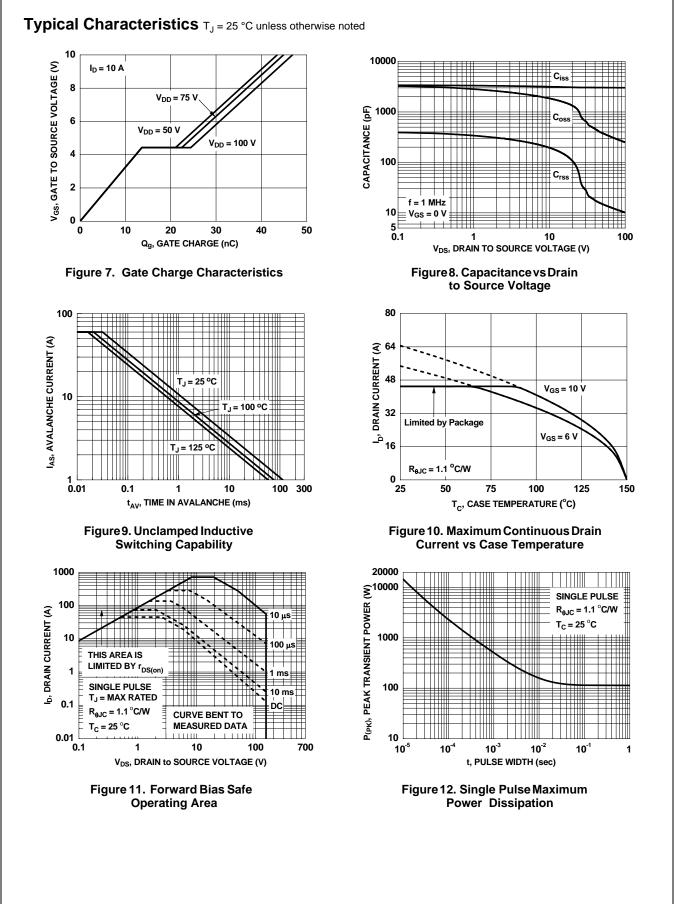
a. 45 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

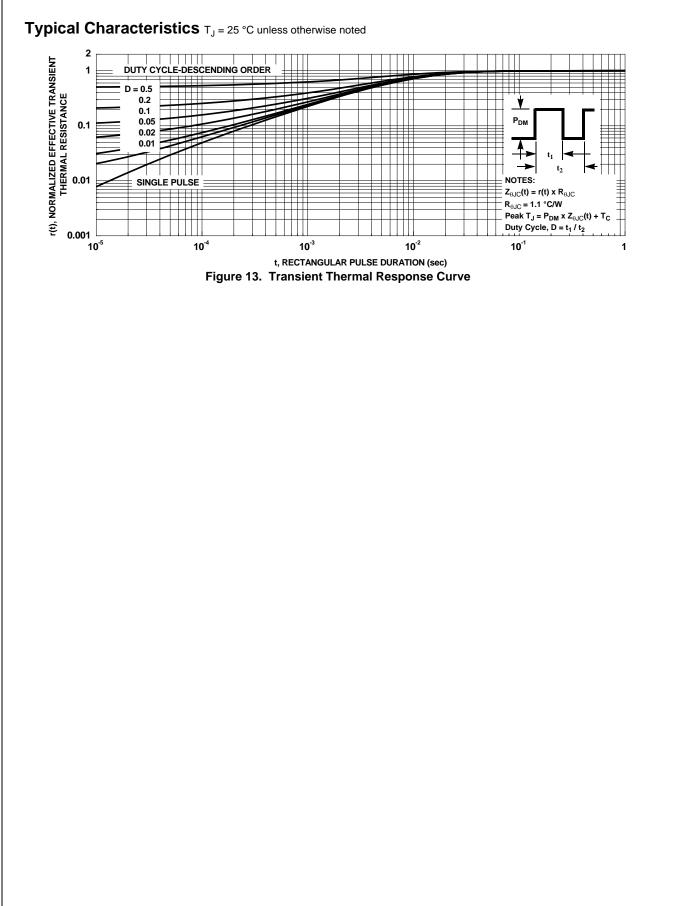
3.  $E_{AS}$  of 541 mJ is based on starting  $T_J$  = 25 °C, L = 3 mH,  $I_{AS}$  = 19 A,  $V_{DD}$  = 150 V,  $V_{GS}$  = 10 V. 100% tested at L = 0.1 mH,  $I_{AS}$  = 60 A.

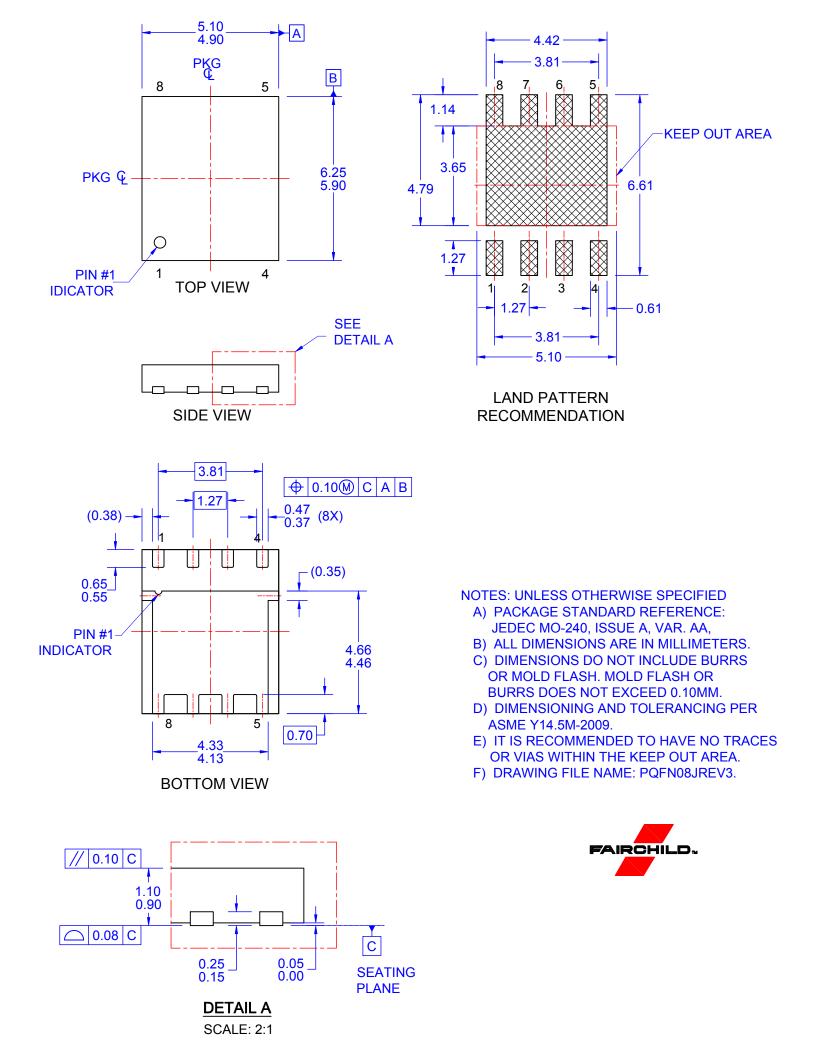


b. 115 °C/W when mounted on a minimum pad of 2 oz copper.









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